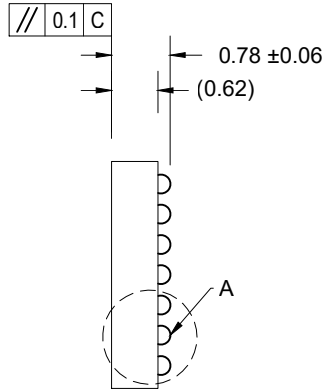
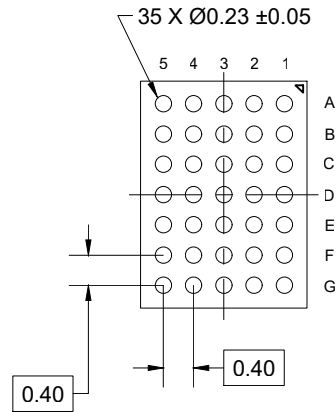


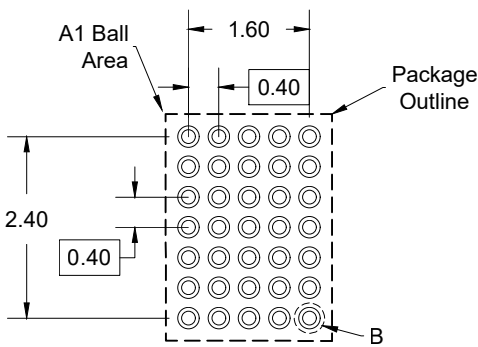
TOP VIEW



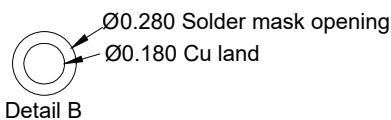
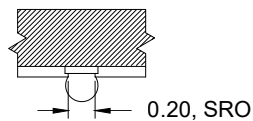
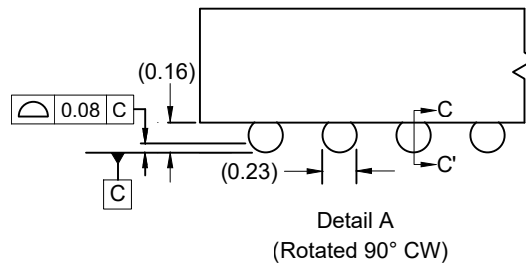
SIDE VIEW



BOTTOM VIEW



RECOMMENDED LAND PATTERN  
(PCB Top View, NSMD Design)



**NOTES:**

1. JEDEC compatible.
2. All dimensions are in mm and angles are in degrees.
3. Use  $\pm 0.05$  mm for the non-toleranced dimensions.
4. Numbers in ( ) are for references only.
5. Pre-reflow solderball diameter is  $\text{Ø}0.22$  mm.